RELIABILITY DELIVERED



POWER MODULES

- High-temperature solder paste
- InFORMS®
- Die-attach materials
- Thermal Interface Materials (TIMs)
- Heat-Spring®

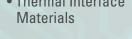






MEMS

- Preforms
- Solder paste
- Die-attach materials
- Lid attach materials
- Thermal Interface Materials





LED

- Low-temperature solder paste
- Preforms
- Die-attach materials
- AuSn solders
- In and Ga compounds for LED lights

FUTURE APPLICATIONS

- Fine powders
- Indium compounds for Sn whisker elimination
- InFORMS®
- Novel compounds
- Developmental opportunities



Full Line of Materials Full Line of iviateria for all Aspects of Assembly

High-Reliability Under Hood

- ≥125°C operating temperature - Indalloy®276
- Meets HKMC MS184-01 testing criteria

High Electrical Reliability

 High ECM performance - Indium10.1HF Solder Paste

AVOID岸VOID

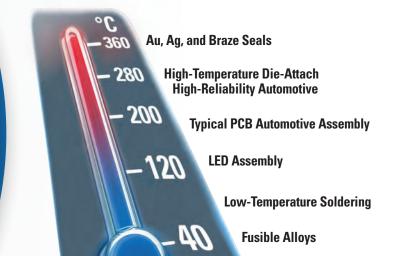
- Very low-voiding for QFN, DPAK, and BGA
- Indium8.9HF Solder Paste
- Indium10.1HF Solder Paste

Additional Products:

- Solder Fortification® Preforms
- Cored Wire
- Wave Flux Bar Solder

Indium10.1HF Solder Paste

THE RIGHT SOLDER ALLOY FOR THE RIGHT APPLICATION





Contact tech support for

your ideal alloy solution!

INDIUM CORPORATION

WORLDWIDE

Our Goal

Increase our customers' productivity and profitability through the design, application, and service of advanced materials.

Corporate Quality Policy

- Provide quality products that meet or exceed customer needs, expectations and requirements
- Create an organizational culture that focuses on meeting requirements and continuous improvement
- Have products that are compliant with relevant laws and regulations
- Focus on defect prevention
- Respond to input from external and internal customers
- Identify and provide necessary resources

Global Technical Support



Automotive Electronics Council (AEC)





KEMET























RELNET_VX

















































Global Technical Support and Facilities Worldwide



Contact our engineers: askus@indium.com Learn more: www.indium.com

All of Indium Corporation's solder paste and preform manufacturing facilities are IATF 16949:2016 certified. Indium Corporation is an ISO 9001:2015 registered company.





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AUTOMOTIVE

High-quality, exceptional solder products designed to seamlessly integrate for increased overall reliability.



